

SCCS054C - August 1994 - Revised October 2003

16-Bit Latches

Features

- Ioff supports partial-power-down mode operation
- Edge-rate control circuitry for significantly improved noise characteristics
- Typical output skew < 250 ps
- ESD > 2000V
- TSSOP (19.6-mil pitch) and SSOP (25-mil pitch) packages
- Industrial temperature range of -40°C to +85°C
- $V_{CC} = 5V \pm 10\%$

CY74FCT16373T Features:

- 64 mA sink current, 32 mA source current
- Typical V_{OLP} (ground bounce) <1.0V at V_{CC} = 5V, T_A = 25°C

CY74FCT162373T Features:

- · Balanced 24 mA output drivers
- · Reduced system switching noise
- Typical V_{OLP} (ground bounce) <0.6V at V_{CC} = 5V, T_A = 25°C

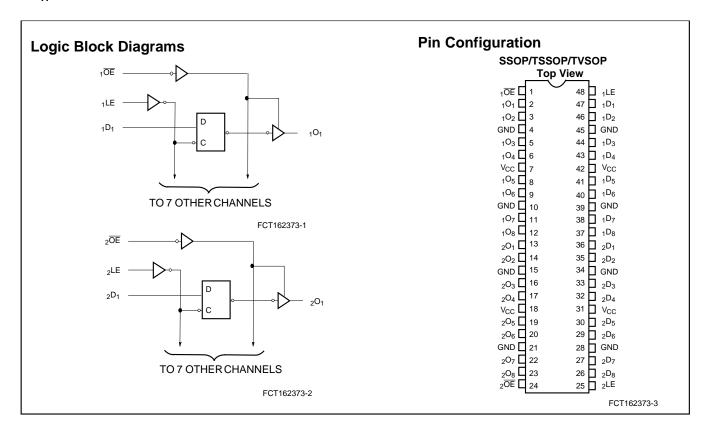
Functional Description

CY74FCT16373T and CY74FCT162373T are 16-bit D-type latches designed for use in bus applications requiring high speed and low power. These devices can be used as two independent 8-bit latches or as a single 16-bit latch by connecting the Output Enable (\overline{OE}) and Latch (LE) inputs. Flow-through pinout and small shrink packaging aid in simplifying board layout.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The CY74FCT16373T is ideally suited for driving high-capacitance loads and low-impedance backplanes.

The CY74FCT162373T has 24-mA balanced output drivers with current limiting resistors in the outputs. This reduces the need for external terminating resistors and provides for minimal undershoot and reduced ground bounce. The CY74FCT162373T is ideal for driving transmission lines.





Pin Description

| Name | Description |
|------|-----------------------------------|
| D | Data Inputs |
| LE | Latch Enable Inputs (Active HIGH) |
| ŌĒ | Output Enable Inputs (Active LOW) |
| 0 | Three-State Outputs |

Function Table^[1]

| | Inputs | | | |
|---|--------|----|-------|--|
| D | LE | ŌĒ | 0 | |
| Н | Н | L | Н | |
| L | Н | L | L | |
| Х | L | L | Q_0 | |
| Х | Х | Н | Z | |

Maximum Ratings^[2, 3]

| (Above which the useful life may be impaired. For user guidelines, not tested.) |
|---|
| Storage Temperature Com'I -55°C to +125°C |
| Ambient Temperature with Power Applied |
| DC Input Voltage0.5V to +7.0V |
| DC Output Voltage0.5V to +7.0V |
| DC Output Current (Maximum Sink Current/Pin)60 to +120 mA |
| Power Dissipation |
| Static Discharge Voltage>2001V (per MIL-STD-883, Method 3015) |

Operating Range

| Range | Ambient Temperature | V _{CC} |
|------------|------------------------|-----------------|
| Industrial | –40°C to +85°C | 5V ± 10% |

Electrical Characteristics Over the Operating Range

| Parameter | Description | Test Conditions | Min. | Typ. ^[4] | Max. | Unit |
|------------------|---|--|------|---------------------|------|------|
| V _{IH} | Input HIGH Voltage | | 2.0 | | | V |
| V _{IL} | Input LOW Voltage | | | | 0.8 | V |
| V _H | Input Hysteresis ^[5] | | | 100 | | mV |
| V _{IK} | Input Clamp Diode Voltage | V _{CC} =Min., I _{IN} =-18 mA | | -0.7 | -1.2 | V |
| I _{IH} | Input HIGH Current | V _{CC} =Max., V _I =V _{CC} | | | ±1 | μΑ |
| I _{IL} | Input LOW Current | V _{CC} =Max., V _I =GND | | | ±1 | μΑ |
| l _{OZH} | High Impedance Output Current (Three-State Output pins) | V _{CC} =Max., V _{OUT} =2.7V | | | ±1 | μΑ |
| l _{OZL} | High Impedance Output Current (Three-State Output pins) | V _{CC} =Max., V _{OUT} =0.5V | | | ±1 | μΑ |
| I _{OS} | Short Circuit Current ^[6] | V _{CC} =Max., V _{OUT} =GND | -80 | -140 | -200 | mA |
| Io | Output Drive Current ^[6] | V _{CC} =Max., V _{OUT} =2.5V | -50 | | -180 | mA |
| I _{OFF} | Power-Off Disable | V _{CC} =0V, V _{OUT} ≤4.5V ^[7] | | | ±1 | μΑ |

Output Drive Characteristics for CY74FCT16373T

| Parameter | Description | Test Conditions | Min. | Typ. ^[4] | Max. | Unit |
|-----------------|---------------------|--|------|---------------------|------|------|
| V _{OH} | Output HIGH Voltage | V _{CC} =Min., I _{OH} =-3 mA | 2.5 | 3.5 | | V |
| | | V _{CC} =Min., I _{OH} =-15 mA | 2.4 | 3.5 | | V |
| | | V _{CC} =Min., I _{OH} =-32 mA | 2.0 | 3.0 | | V |
| V _{OL} | Output LOW Voltage | V _{CC} =Min., I _{OL} =64 mA | | 0.2 | 0.55 | V |

- H = HIGH Voltage Level. L = LOW Voltage Level. X = Don't Care. Z = High Impedance. Q₀=Previous state of flip-flop.

 Operation beyond the limits set forth may impair the useful life of the device. Unless otherwise noted, these limits are over the operating free-air temperature range. Unused inputs must always be connected to an appropriate logic voltage level, preferably either V_{CC} or ground.

- Typical values are at V_{CC}=5.0V, T_A= +25°C ambient.

 This parameter is specified but not tested.

 Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample Not filled that one output should be shorted at a time. Dutation of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametric tests. In any sequence of parameter tests, I_{OS} tests should be performed last.
 Tested at +25°C.



Output Drive Characteristics for CY74FCT162373T

| Parameter | Description | Test Conditions | Min. | Typ. ^[4] | Max. | Unit |
|------------------|------------------------------------|---|------|---------------------|------|------|
| I _{ODL} | Output LOW Current ^[6] | V _{CC} =5V, V _{IN} =V _{IH} or V _{IL} , V _{OUT} =1.5V | 60 | 115 | 150 | mA |
| I _{ODH} | Output HIGH Current ^[6] | V_{CC} =5V, V_{IN} = V_{IH} or V_{IL} , V_{OUT} =1.5V | -60 | -115 | -150 | mA |
| V _{OH} | Output HIGH Voltage | V _{CC} =Min., I _{OH} =-24 mA | 2.4 | 3.3 | | V |
| V _{OL} | Output LOW Voltage | V _{CC} =Min., I _{OL} =24 mA | | 0.3 | 0.55 | V |

Capacitance^[5] ($T_A = +25^{\circ}C$, f = 1.0 MHz)

| Parameter | Description | Test Conditions | Typ. ^[4] | Max. | Unit |
|------------------|--------------------|-----------------------|---------------------|------|------|
| C _{IN} | Input Capacitance | $V_{IN} = 0V$ | 4.5 | 6.0 | pF |
| C _{OUT} | Output Capacitance | V _{OUT} = 0V | 5.5 | 8.0 | pF |

Power Supply Characteristics

| Parameter | Description | Test Condition | ons | Typ. ^[4] | Max. | Unit |
|------------------|--|--|--|----------------------------|----------------------|--------|
| I _{CC} | Quiescent Power Supply Current | V _{CC} =Max. | V _{IN} ≤0.2V, V _{IN} ≥V _{CC} −0.2V | 5 | 500 | μΑ |
| Δl _{CC} | Quiescent Power Supply Current (TTL inputs HIGH) | V _{CC} =Max. | V _{IN} =3.4V ^[8] | 0.5 | 1.5 | mA |
| I _{CCD} | Dynamic Power Supply Current ^[9] | V _{CC} =Max., One Input Toggling, 50% <u>Duty</u> Cycle, Outputs Open, OE=GND | V _{IN} =V _{CC} or V _{IN} =GND | 60 | 100 | μA/MHz |
| I _C | Total Power Supply Current ^[10] | V _{CC} =Max., f ₁ =10 MHz, 50% Duty Cycle, Outputs | V _{IN} =V _{CC} or V _{IN} =GND | 0.6 | 1.5 | mA |
| | | Open, One Bit Toggling, OE=GND, LE=V _{CC} | V _{IN} =3.4V or V _{IN} =GND | 0.9 | 2.3 | mA |
| | | V _{CC} =Max., f ₁ =2.5 MHz, 50% Duty Cycle, Outputs | V _{IN} =V _{CC} or V _{IN} =GND | 2.4 | 4.5 ^[11] | mA |
| | | Open, Sixteen Bits Toggling, OE=GND, LE=V _{CC} | V _{IN} =3.4V or V _{IN} =GND | 6.4 | 16.5 ^[11] | mA |

Notes:
8. Per TTL driven input (V_{IN}=3.4V); all other inputs at V_{CC} or GND.
9. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
10. I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}
I_C = Quiescent Current with CMOS input levels
ΔI_{CC} = Power Supply Current for a TTL HIGH input(V_{IN}=3.4V)
D_H = Duty Cycle for TTL inputs HIGH
N_T = Number of TTL inputs at D_H
I_{CCD} = Dynamic Current caused by an input transition pair (HLH or LHL)
f₀ = Clock frequency for registered devices, otherwise zero
f₁ = Input signal frequency
N₁ = Number of inputs changing at f₁
All currents are in milliamps and all frequencies are in megahertz.
11. Values for these conditions are examples of the I_{CC} formula. These limits are specified but not tested.



Switching Characteristics Over the Operating Range^[12]

| | | CY74FCT16373AT CY74FCT162373AT | | | |
|--------------------------------------|----------------------------------|-----------------------------------|------|------|--------------------------|
| Parameter | Description | Min. | Max. | Unit | Fig. No. ^[13] |
| t _{PLH} t _{PHL} | Propagation Delay D to O | 1.5 | 5.2 | ns | 1, 3 |
| t _{PLH} t _{PHL} | Propagation Delay LE to O | 2.0 | 6.7 | ns | 1, 5 |
| t _{PZH} t _{PZL} | Output Enable Time | 1.5 | 6.1 | ns | 1, 7, 8 |
| t _{PHZ} t _{PLZ} | Output Disable Time | 1.5 | 5.5 | ns | 1, 7, 8 |
| t _{SU} | Set-Up Time HIGH or LOW, D to LE | 2.0 | | ns | 9 |
| t _H | Hold Time HIGH or LOW, D to LE | 1.5 | | ns | 9 |
| t _W | LE Pulse Width HIGH | 3.3 | | ns | 5 |
| t _{SK(O)} | Output Skew ^[14] | | 0.5 | ns | _ |

| | | CY74FCT16373CT CY74FCT162373CT | | | |
|--------------------------------------|-----------------------------------|-----------------------------------|------|------|--------------------------|
| Parameter | Description | Min. | Max. | Unit | Fig. No. ^[13] |
| t _{PLH} t _{PHL} | Propagation Delay D to O | 1.5 | 4.2 | ns | 1, 3 |
| t _{PLH} t _{PHL} | Propagation Delay LE to O | 2.0 | 5.5 | ns | 1, 5 |
| t _{PZH} t _{PZL} | Output Enable Time | 1.5 | 5.5 | ns | 1, 7, 8 |
| t _{PHZ} t _{PLZ} | Output Disable Time | 1.5 | 5.0 | ns | 1, 7, 8 |
| t _{SU} | Set-Up Time HIGH or LOW, D to LE | 2.0 | | ns | 9 |
| t _H | Hold Time HIGH or LOW, D to LE | 1.5 | | ns | 9 |
| t _W | LE Pulse Width HIGH | 3.3 | | ns | 5 |
| t _{SK(O)} | Output Skew ^[14] | | 0.5 | ns | _ |

Minimum limits are specified but not tested on Propagation Delays.
 See "Parameter Measurement Information" in the General Information section.
 Skew between any two outputs of the same package switching in the same direction. This parameter is ensured by design.



Ordering Information CY74FCT16373

| Speed (ns) | Ordering Code | Package Name | Package Type | Operating Range |
|------------|------------------------|-----------------|-------------------------|--------------------|
| 4.2 | CY74FCT16373CTPACT | Z48 | 48-Lead (240-Mil) TSSOP | Industrial |
| | CY74FCT16373CTPVC/PVCT | O48 | 48-Lead (300-Mil) SSOP | |
| | CY74FCT16373CTVR | - | 48-Lead (173-Mil) TVSOP | |
| 5.2 | CY74FCT16373ATPACT | Z48 | 48-Lead (240-Mil) TSSOP | Industrial |
| | CY74FCT16373ATPVC/PVCT | O48 | 48-Lead (300-Mil) SSOP | |
| | CY74FCT16373ATVR | - | 48-Lead (173-Mil) TVSOP | |

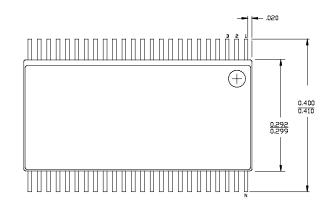
Ordering Information CY74FCT162373

| Speed (ns) | Ordering Code | Package Name | Package Type | Operating Range |
|---------------|--------------------|-----------------|-------------------------|--------------------|
| 4.2 | 74FCT162373CTPACT | Z48 | 48-Lead (240-Mil) TSSOP | Industrial |
| | CY74FCT162373CTPVC | O48 | 48-Lead (300-Mil) SSOP | |
| | 74FCT162373CTPVCT | O48 | 48-Lead (300-Mil) SSOP | |
| 5.2 | 74FCT162373ATPACT | Z48 | 48-Lead (240-Mil) TSSOP | Industrial |
| | CY74FCT162373ATPVC | O48 | 48-Lead (300-Mil) SSOP | |
| | 74FCT162373ATPVCT | O48 | 48-Lead (300-Mil) SSOP | |

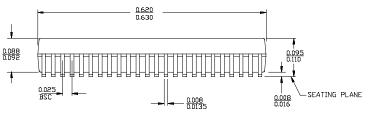


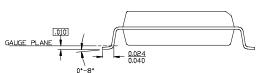
Package Diagrams

48-Lead Shrunk Small Outline Package O48

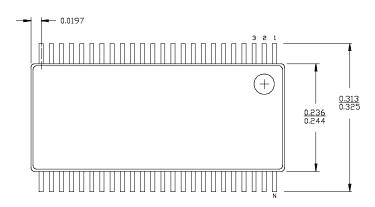


DIMENSIONS IN INCHES MIN. MAX.

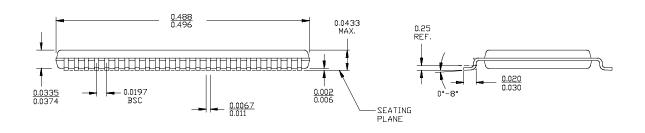




48-Lead Thin Shrunk Small Outline Package Z48



DIMENSIONS IN INCHES MIN. MAX.







6-Feb-2020

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|--------------------|------------|--------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|----------------------|---------|
| 74FCT162373ATPACT | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT162373A | Samples |
| 74FCT162373ATPVCG4 | ACTIVE | SSOP | DL | 48 | 25 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT162373A | Samples |
| 74FCT162373ATPVCT | ACTIVE | SSOP | DL | 48 | 1000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT162373A | Samples |
| CY74FCT162373ATPVC | ACTIVE | SSOP | DL | 48 | 25 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT162373A | Samples |
| CY74FCT162373CTPVC | ACTIVE | SSOP | DL | 48 | 25 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT162373C | Samples |
| CY74FCT16373ATPACT | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT16373A | Samples |
| CY74FCT16373ATPVC | ACTIVE | SSOP | DL | 48 | 25 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT16373A | Samples |
| CY74FCT16373ATPVCT | ACTIVE | SSOP | DL | 48 | 1000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT16373A | Samples |
| CY74FCT16373CTPACT | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT16373C | Samples |
| CY74FCT16373CTPVC | ACTIVE | SSOP | DL | 48 | 25 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT16373C | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



PACKAGE OPTION ADDENDUM

6-Feb-2020

- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| 74FCT162373ATPACT | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 13.0 | 1.8 | 12.0 | 24.0 | Q1 |
| 74FCT162373ATPVCT | SSOP | DL | 48 | 1000 | 330.0 | 32.4 | 11.35 | 16.2 | 3.1 | 16.0 | 32.0 | Q1 |
| CY74FCT16373ATPACT | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 13.0 | 1.8 | 12.0 | 24.0 | Q1 |
| CY74FCT16373ATPVCT | SSOP | DL | 48 | 1000 | 330.0 | 32.4 | 11.35 | 16.2 | 3.1 | 16.0 | 32.0 | Q1 |
| CY74FCT16373CTPACT | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 13.0 | 1.8 | 12.0 | 24.0 | Q1 |

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*All dimensions are nominal

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|---------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| 74FCT162373ATPACT | TSSOP | DGG | 48 | 2000 | 367.0 | 367.0 | 45.0 |
| 74FCT162373ATPVCT | SSOP | DL | 48 | 1000 | 367.0 | 367.0 | 55.0 |
| CY74FCT16373ATPACT | TSSOP | DGG | 48 | 2000 | 367.0 | 367.0 | 45.0 |
| CY74FCT16373ATPVCT | SSOP | DL | 48 | 1000 | 367.0 | 367.0 | 55.0 |
| CY74FCT16373CTPACT | TSSOP | DGG | 48 | 2000 | 367.0 | 367.0 | 45.0 |

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

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DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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